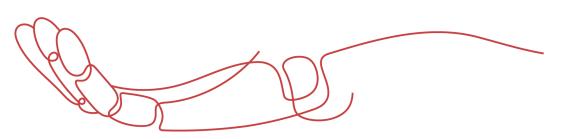




PRODUCT DATA SHEET



To learn more about JGSEMI, please visit our website at







Datasheet

es Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.



Ultra Low Capacitance Bi-Directional TVS Diode Array

Features

Ultra low leakage: nA levelOperating voltage: 12V

Low clamping voltage

• Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±15kV

Contact discharge: ±8kV

- IEC61000-4-4 (EFT) 40A (5/50ns)

- IEC61000-4-5 (Lightning) 12A (8/20μs)

RoHS Compliant

Applications

• USB 2.0 power and data line

Set-top box and digital TV

Digital video interface (DVI)

Notebook Computers

SIM Ports

10/100 Ethernet

Mechanical Characteristics

Package: SOD-323

Lead Finish: Lead Free

UL Flammability Classification Rating 94V-0

Quantity Per Reel:3,000pcs

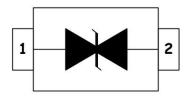
Reel Size:7 inch

Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|---------------------------------|--------|-------------|------------|
| Peak Pulse Power (8/20µs) | Ррр | 320 | W |
| ESD per IEC 61000-4-2 (Air) | Vesd | ± 15 | Kv |
| ESD per IEC 61000-4-2 (Contact) | VESD | ± 8 | INV |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | Тѕтј | -55 to +150 | $^{\circ}$ |



SOD-323





Electrical Characteristics (TA=25°C unless otherwise specified)

| | $V_{\sf RWM}$ | $V_{\sf BR}$ | Ιτ | | Vc | | I R | С |
|-------------|---------------|--------------|------|----|-------|------|-------------|----------------|
| Part Number | (V) | (V) | (mA) | | (Max) | (@A) | μΑ (Max) | (Pf) (Typ.) |
| SD12C | 12 | 13.3 | 1 | 19 | 25 | 13 | 1 | 56 |

Characteristic Curves

Fig1. 8/20 µs Pulse Waveform

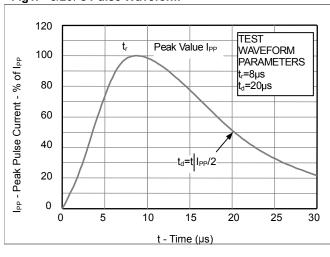


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

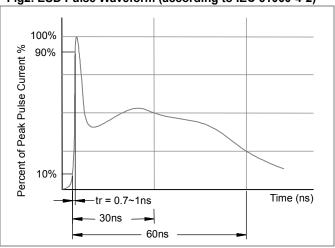
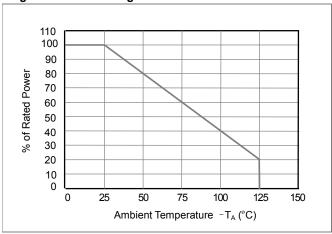
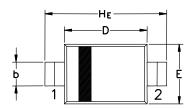


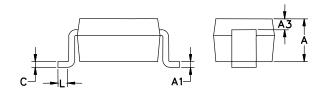
Fig3. Power Derating Curve





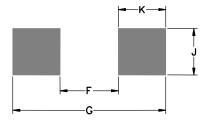
SOD-323 Package Outline & Dimensions





| 0 1 | Millimeters | | | Inches | | |
|------------|-------------|------|-------|-----------|-------|-------|
| Symbol | Min. | Nom. | Max. | Min. | Nom. | Max. |
| Α | 0.80 | 0.90 | 1.00 | 0.031 | 0.035 | 0.040 |
| A 1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 |
| А3 | 0.15 REF | | | 0.006 REF | | |
| b | 0.25 | 0.32 | 0.40 | 0.010 | 0.012 | 0.016 |
| С | 0.089 | 0.12 | 0.177 | 0.003 | 0.005 | 0.007 |
| D | 1.60 | 1.70 | 1.80 | 0.062 | 0.066 | 0.070 |
| E | 1.15 | 1.25 | 1.35 | 0.045 | 0.049 | 0.053 |
| L | 0.08 | | | 0.003 | | |
| HE | 2.30 | 2.50 | 2.70 | 0.090 | 0.098 | 0.105 |

Soldering Footprint



| Symbol | Millimeters | Inches | | |
|--------|-------------|--------|--|--|
| F | 1.60 | 0.063 | | |
| G | 2.85 | 0.112 | | |
| J | 0.83 | 0.033 | | |
| K | 0.63 | 0.025 | | |



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